



GP
ELECTRONICS

GPK2333

12V P-Channel MOSFET

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
-12V	19m Ω @-4.5V	-6A
	21m Ω @-3.7V	
	27m Ω @-2.5V	
	35m Ω @-1.8V	
	50m Ω @-1.5V	

Feature

- TrenchFET Power MOSFET
- Excellent $R_{DS(on)}$ and Low Gate Charge

Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

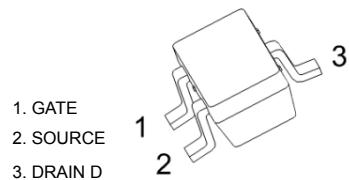
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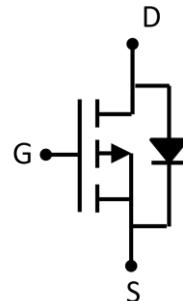
ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-12	V
Gate-Source Voltage	V_{GS}	± 8	V
Continuous Drain Current ^{1,2}	I_D	-6	A
Pulsed Drain Current ($t=300\mu s$)	I_{DM}	-20	A
Power Dissipation	P_D	0.4	W
Thermal Resistance from Junction to Ambient ^{1,2}	$R_{\theta JA}$	312.5	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55~+150	°C

SOT-23-3L



Schematic diagram



MOSFET ELECTRICAL CHARACTERISTICS($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$	-12			V
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = -12\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate-body leakage current	I_{GSS}	$V_{\text{GS}} = \pm 8\text{V}, V_{\text{DS}} = 0\text{V}$			± 0.1	μA
On Characteristics						
Gate threshold voltage ³	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = -250\mu\text{A}$	-0.4	-0.65	-1	V
Drain-source on-resistance ³	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -5\text{A}$		19	28	$\text{m}\Omega$
		$V_{\text{GS}} = -3.7\text{V}, I_{\text{D}} = -4.6\text{A}$		21	32	
		$V_{\text{GS}} = -2.5\text{V}, I_{\text{D}} = -4.3\text{A}$		27	40	
		$V_{\text{GS}} = -1.8\text{V}, I_{\text{D}} = -1\text{A}$		35	63	
		$V_{\text{GS}} = -1.5\text{V}, I_{\text{D}} = -0.5\text{A}$		50	150	
Forward transconductance ³	g_{FS}	$V_{\text{DS}} = -5\text{V}, I_{\text{D}} = -5\text{A}$	10	14		S
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -6\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		1275		pF
Output Capacitance	C_{oss}			255		
Reverse Transfer Capacitance	C_{rss}			236		
Switching Characteristics						
Gate resistance	R_g	$f = 1\text{MHz}$	1.9		19	Ω
Total Gate Charge	Q_g	$V_{\text{DS}} = -6\text{V}, V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -5\text{A}$		14		nC
Gate-Source Charge	Q_{gs}			2.3		
Gate-Drain Charge	Q_{gd}			3.6		
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DS}} = -6\text{V}, V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -4\text{A}$ $R_L = 6\Omega, R_g = 1\Omega$		26		ns
Turn-on rise time	t_r			24		
Turn-off delay time	$t_{\text{d}(\text{off})}$			45		
Turn-off fall time	t_f			20		
Source-Drain Diode Characteristics						
Diode forward current	I_s	$T_c=25^\circ\text{C}$			-6	A
Diode pulsed forward current	I_{SM}				-20	A
Diode Forward voltage ^a	V_{DS}	$V_{\text{GS}} = 0\text{V}, I_s = -4\text{A}$			-1.2	V
Diode reverse recovery time ^b	t_{rr}	$ I_F = -4\text{A}, dI/dt = 100\text{A}/\mu\text{s}$		24	48	ns
Diode reverse recovery charge ^b	Q_{rr}			8	16	nC

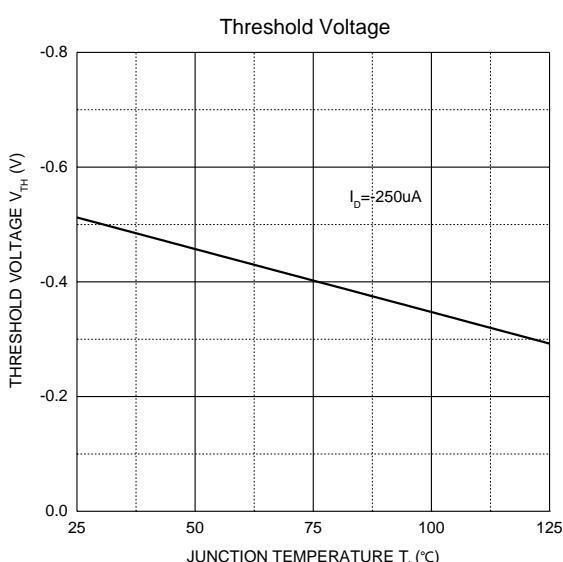
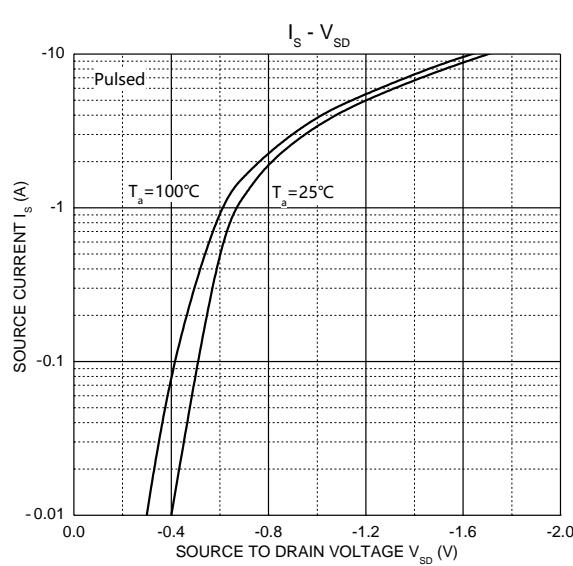
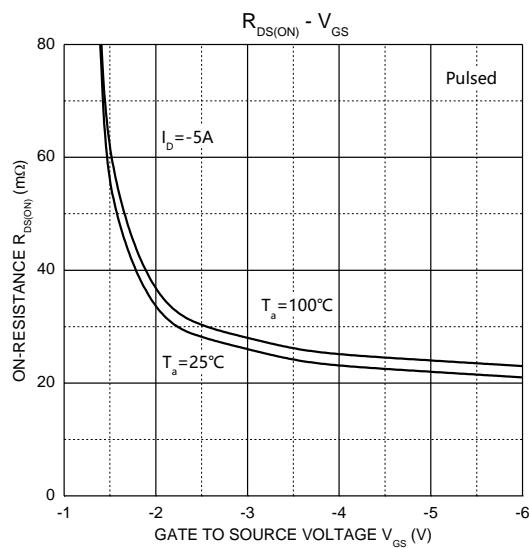
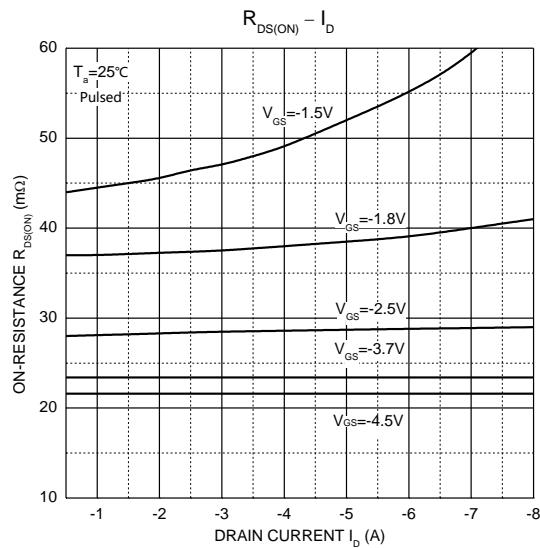
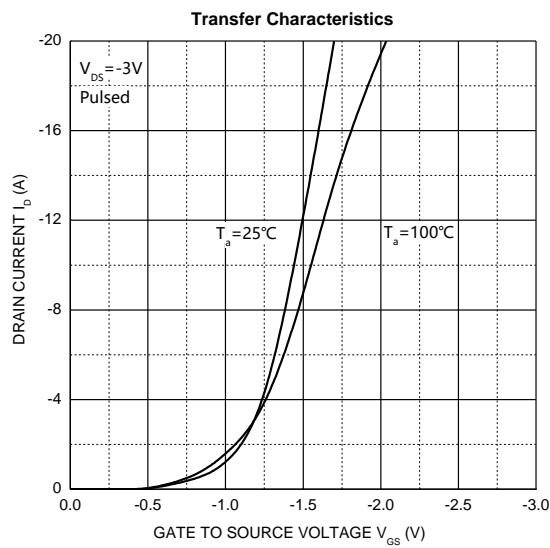
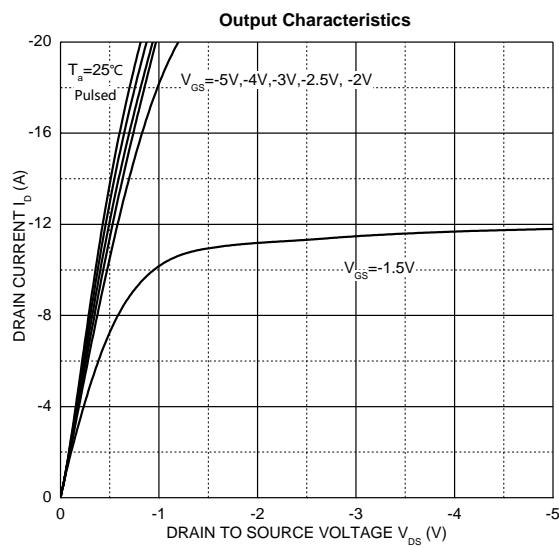
Notes :

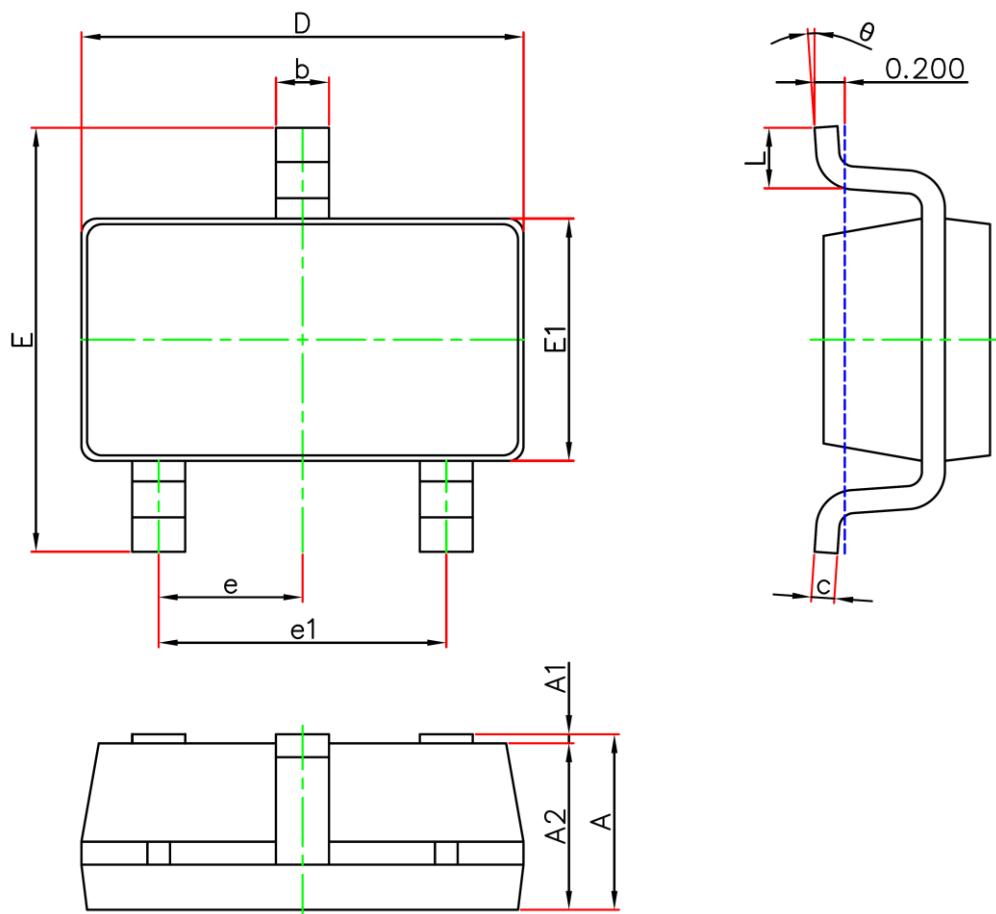
1. $R_{\theta JA}$ is measured with the device mounted on 1 in² FR4 board with 1oz. single side copper, in a still air environment with $T_A = 25^\circ\text{C}$.

2. $R_{\theta JA}$ is measured in the steady state

3. Pulse test : Pulse width $\leq 380\mu\text{s}$, duty cycle $\leq 2\%$.

Typical Electrical and Thermal Characteristics



SOT-23-3L Package Outline Dimensions


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0	0.150	0.000	0.006
A2	1.050	1.250	0.041	0.049
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	2.650	2.950	0.104	0.116
E1	1.500	1.700	0.059	0.067
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°